



500.38665CX1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): SHIMOKAWA, et al.

Serial No.: 09/972,178

Filed: October 9, 2001

For: PB-FREE SOLDER-CONNECTED STRUCTURE AND  
ELECTRONIC DEVICE

Group: 1775

Examiner: J. Zimmerman

AMENDMENT

Assistant Commissioner for Patents  
Washington, D.C. 20231

RECEIVED

MAR 21 2002

TC 1700

March 18, 2002

Sir:

In response to the Office Action mailed December 17, 2001, please  
amend the above-identified application as follows:

IN THE CLAIMS

Please cancel claims 15-18 and 28-39 without prejudice or disclaimer,  
and amend the claims remaining in the application as follows:

1. (Amended) An electronic device comprising a substrate and a  
semiconductor device, which are connected with each other by means of a Pb-